

## High Voltage LED Series Chip on Board

# LC019D – Gen.2



High efficacy COB LED package  
well-suited for use in spotlight applications

### Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability



### Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination

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## 1. Characteristics

### a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	$T_a$	-40 ~ +105	°C	-
Storage Temperature	$T_{stg}$	-40 ~ +120	°C	-
LED Junction Temperature	$T_J$	140	°C	-
Case Temperature	$T_C$	115	°C	-
Forward Current	$I_F$	1380	mA	-
Power Dissipation	$P_D$	51.8	W	-
ESD (HBM)	-	±2	kV	-
ESD (MM)	-	±0.5	kV	-

### b) Electro-optical Characteristics ( $I_F = 540 \text{ mA}$ , $T_J = 85 \text{ °C}$ )

Item	Unit	Rank	Min.	Typ.	Max.
Forward Voltage ( $V_F$ )	V	YZ	31.8	34.6	37.5
Color Rendering Index ( $R_a$ )	-	5	80	-	-
		7	90	-	-
Thermal Resistance (junction to case point)	°C/W		-	0.6	-
Beam Angle	°		-	115	-
Nominal Power	W			18.7	

#### Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ( $T_J = T_C = T_a = 85 \text{ °C}$ )
- 2) Samsung maintains measurement tolerance of: forward voltage =  $\pm 5 \%$ , CRI =  $\pm 1$
- 3) Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range.

**c) Luminous Flux Characteristics (I<sub>F</sub> = 540 mA)**

CRI (R <sub>a</sub> ) Min.	Nominal CCT (K)	Flux Rank	Flux @ T <sub>c</sub> = 85 °C (lm)		
			Min.	Typ.	Max.
80	2700	D2	2592	2728	-
	3000	D2	2733	2877	-
	3500	D2	2817	2965	-
	4000	D2	2875	3026	-
	5000	D2	2906	3059	-
	5700	D2	2906	3059	-
	6500	D2	2875	3026	-
90	2700	D2	2219	2336	-
	3000	D2	2327	2449	-
	3500	D2	2412	2539	-
	4000	D2	2465	2594	-
	5000	D2	2467	2596	-

**Notes:**

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature (T<sub>J</sub> = T<sub>C</sub> = 85 °C).
- 2) Samsung maintains measurement tolerance of: Luminous flux = ±7 %, CRI = ±1

## 2. Product Code Information

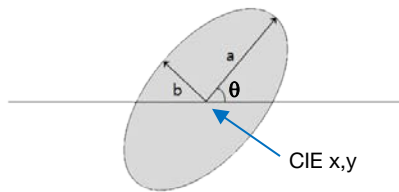
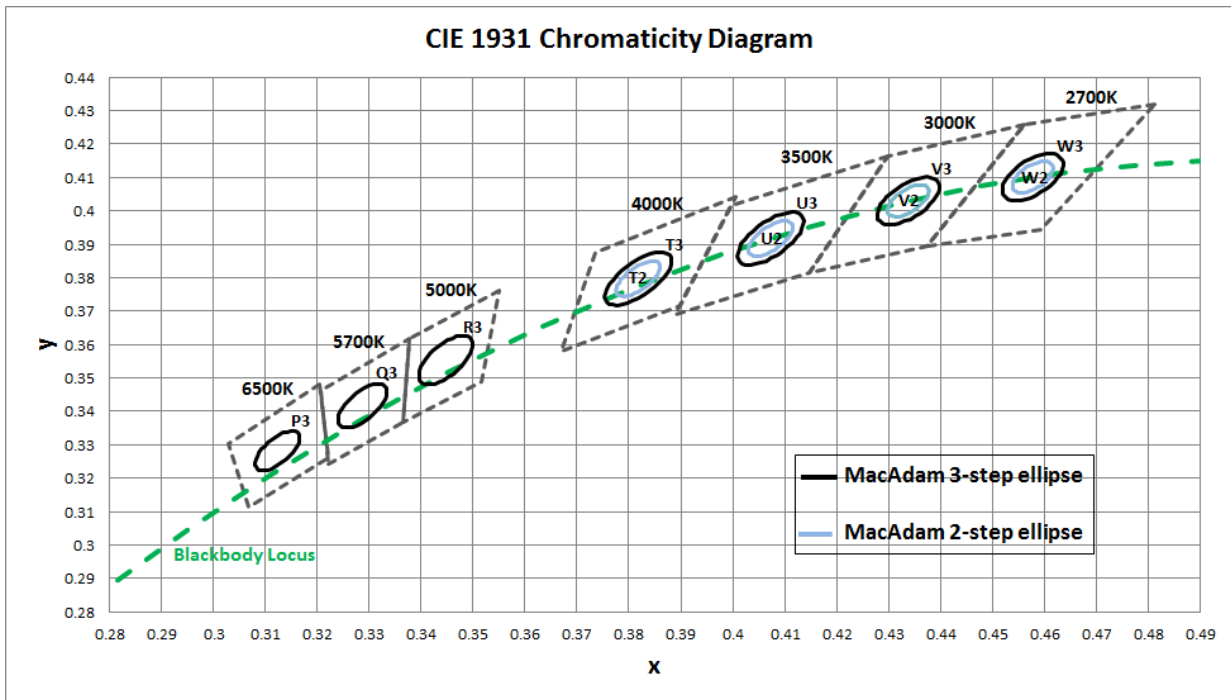
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	H	W	H	A	H	D	N	F	2	5	Y	Z	W	3	D	2

Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	<b>SPH</b>	
4 5	Color	<b>WH</b>	White
6	Product Version	<b>A</b>	
7 8	Form Factor	<b>HD</b>	COB
9	Lens Type	<b>N</b>	No lens
10	Wattage or Model	<b>F</b>	LC019D
11	Internal Code	<b>2</b>	
12	CRI & Sorting Temperature	<b>5</b> <b>7</b>	Min. 80 (85°C) Min. 90 (85°C)
13 14	Forward Voltage (V)	<b>YZ</b>	31.8~37.5
15	CCT (K)	<b>W</b> <b>V</b> <b>U</b> <b>T</b> <b>R</b> <b>Q</b> <b>P</b>	2700K 3000K 3500K 4000K 5000K 5700K 6500K
16	MacAdam Step	<b>2</b> <b>3</b>	MacAdam 2-step MacAdam 3-step
17 18	Luminous Flux (Lm)	<b>D2</b>	COB D-series Gen.2 level

a) Binning Structure ( $I_F = 540 \text{ mA}$ ,  $T_J = 85 \text{ °C}$ )

CRI ( $R_a$ ) Min.	Nominal CCT (K)	Product Code	$V_f$ Rank	Color Rank	Flux Rank	Flux Range ( $\Phi_v$ , lm)
80	2700	SPHWWAHDNF25YZW2D2	YZ	W2	D2	2592 ~
		SPHWWAHDNF25YZW3D2		W3		
	3000	SPHWWAHDNF25YZV2D2	YZ	V2	D2	2733 ~
		SPHWWAHDNF25YZV3D2		V3		
	3500	SPHWWAHDNF25YZU2D2	YZ	U2	D2	2817 ~
		SPHWWAHDNF25YZU3D2		U3		
	4000	SPHWWAHDNF25YZT2D2	YZ	T2	D2	2875 ~
		SPHWWAHDNF25YZT3D2		T3		
	5000	SPHWWAHDNF25YZR3D2	YZ	R3	D2	2906 ~
	5700	SPHWWAHDNF25YZQ3D2	YZ	Q3	D2	2906 ~
	6500	SPHWWAHDNF25YZP3D2	YZ	P3	D2	2875 ~
	90	2700	SPHWWAHDNF27YZW2D2	YZ	W2	D2
SPHWWAHDNF27YZW3D2			W3			
3000		SPHWWAHDNF27YZV2D2	YZ	V2	D2	2327 ~
		SPHWWAHDNF27YZV3D2		V3		
3500		SPHWWAHDNF27YZU2D2	YZ	U2	D2	2412 ~
		SPHWWAHDNF27YZU3D2		U3		
4000		SPHWWAHDNF27YZT2D2	YZ	T2	D2	2465 ~
		SPHWWAHDNF27YZT3D2		T3		
5000		SPHWWAHDNF27YZR3D2	YZ	R3	D2	2467 ~

b) Chromaticity Region & Coordinates ( $I_F = 540 \text{ mA}$ ,  $T_J = 85 \text{ }^\circ\text{C}$ )



MacAdam Ellipse (W2, W3)					
Step	CIE x	CIE y	$\theta$	a	b
2-step	0.4578	0.4101	53.70	0.0054	0.0028
3-step	0.4578	0.4101	53.70	0.0081	0.0042

MacAdam Ellipse (V2, V3)					
Step	CIE x	CIE y	$\theta$	a	b
2-step	0.4338	0.403	53.22	0.0056	0.0027
3-step	0.4338	0.4030	53.22	0.0083	0.0041

MacAdam Ellipse (U2, U3)					
Step	CIE x	CIE y	$\theta$	a	b
2-step	0.4073	0.3917	54.00	0.0062	0.0028
3-step	0.4073	0.3917	54.00	0.0093	0.0041

MacAdam Ellipse (T2, T3)					
Step	CIE x	CIE y	$\theta$	a	b
2-step	0.3818	0.3797	53.72	0.0063	0.0027
3-step	0.3818	0.3797	53.72	0.0094	0.0040

MacAdam Ellipse (R3)					
Step	CIE x	CIE y	$\theta$	a	b
3-step	0.3447	0.3553	59.62	0.0082	0.0035

MacAdam Ellipse (Q3)					
Step	CIE x	CIE y	$\theta$	a	b
3-step	0.3287	0.3417	59.0950	0.0075	0.0032

MacAdam Ellipse (P3)					
Step	CIE x	CIE y	$\theta$	a	b
3-step	0.3123	0.3282	58.5700	0.0067	0.0029

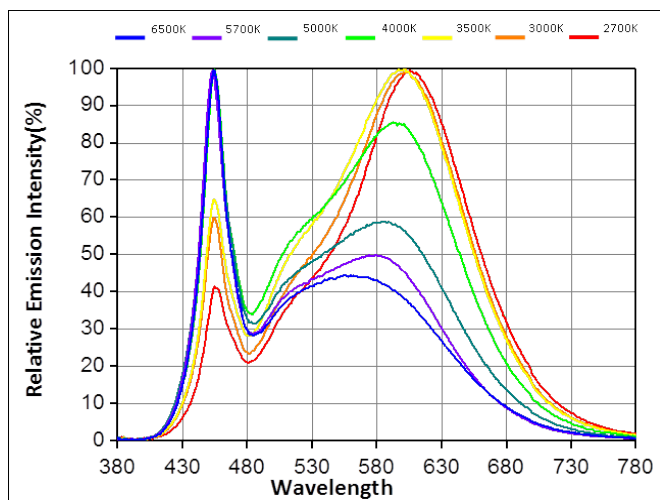
**Note:**

Samsung maintains measurement tolerance of:  $C_x, C_y = \pm 0.005$

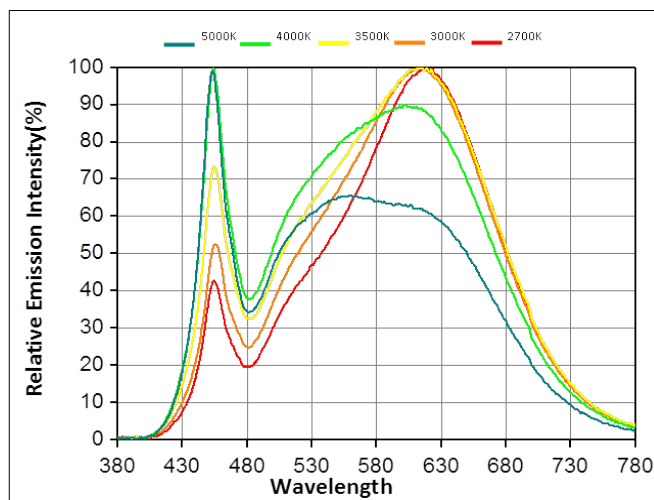
### 3. Typical Characteristics Graphs

#### a) Spectrum Distribution ( $I_f = 540 \text{ mA}$ , $T_J = 85 \text{ }^\circ\text{C}$ )

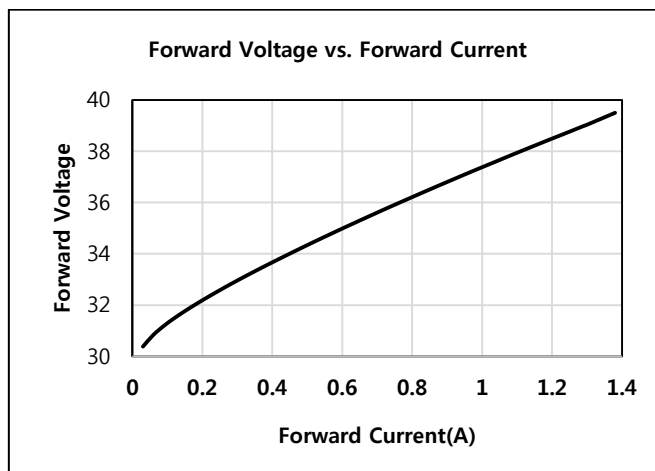
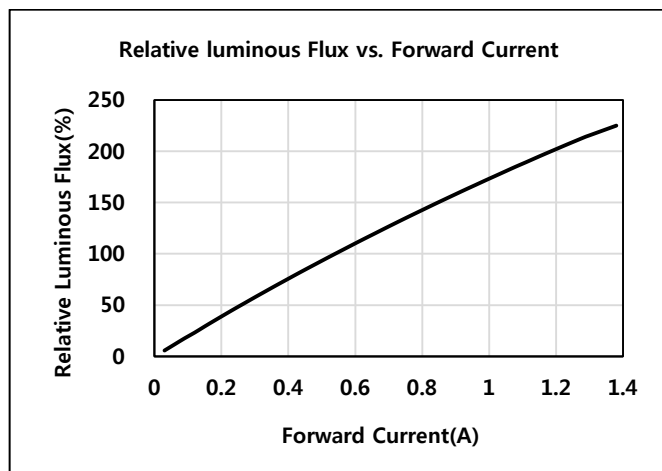
##### CRI Ra 80+



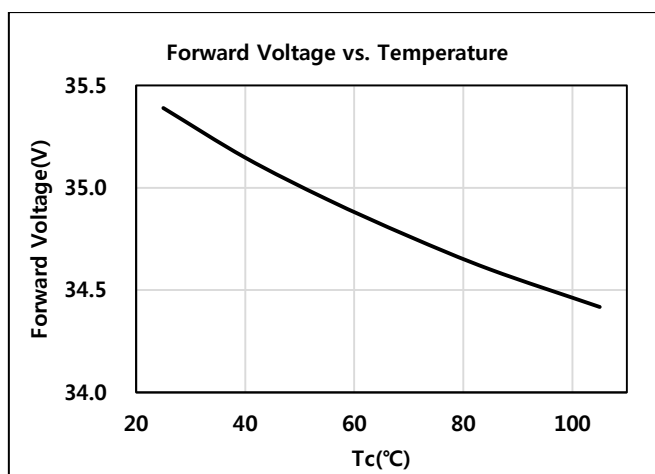
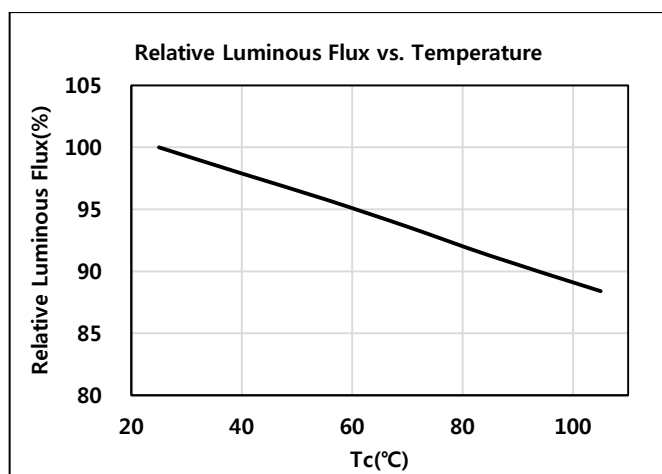
##### CRI Ra 90+



#### b) Forward Current Characteristics ( $T_J = 85 \text{ }^\circ\text{C}$ )

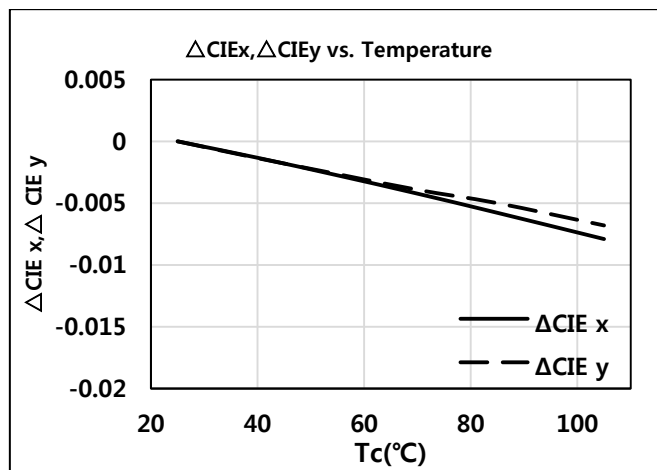
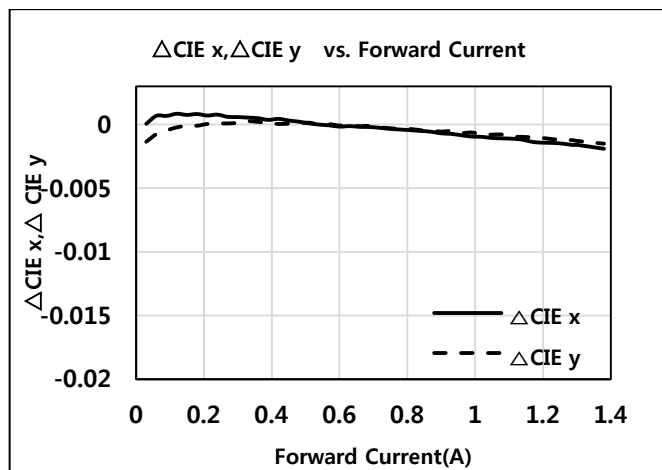


#### c) Temperature Characteristics ( $I_f = 540 \text{ mA}$ )

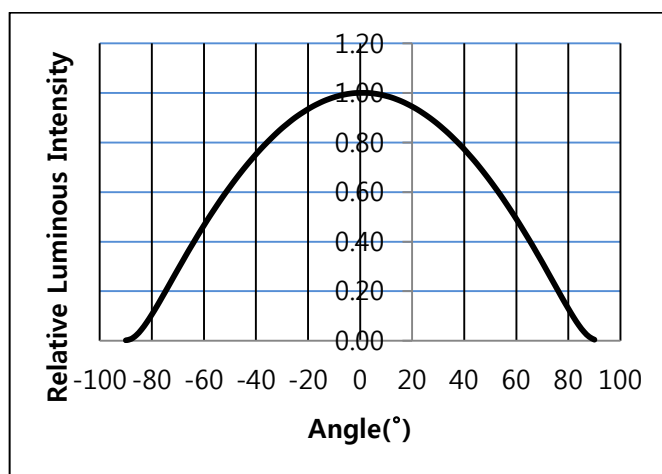




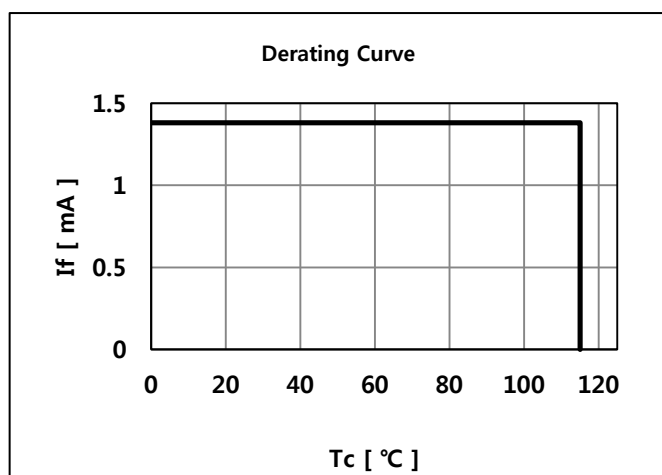
d) Color Shift Characteristics ( $T_J = 85\text{ }^\circ\text{C}$ ,  $I_F = 540\text{mA}$ ,  $\text{CRI} = 80+$ )



f) Beam Angle Characteristics ( $I_F = 540\text{ mA}$ ,  $T_J = 85\text{ }^\circ\text{C}$ )

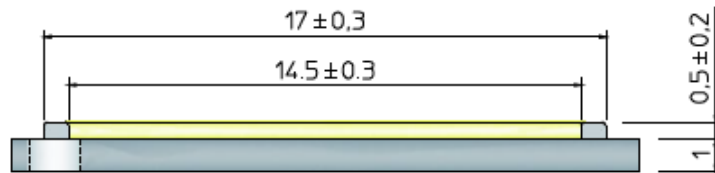
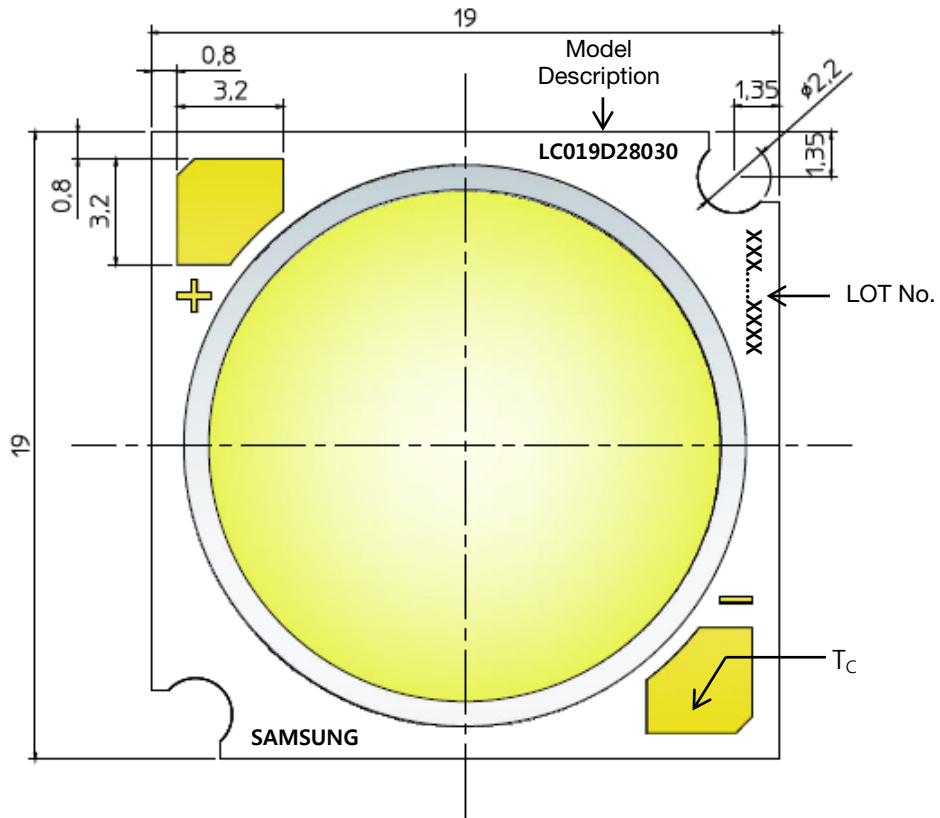


g) Derating Characteristics





4. Outline Drawing & Dimension



- 1. Unit: mm
- 2. Tolerance: ± 0.3 mm

Item	Dimension	Tolerance	Unit
Length	19.0	±0.15	mm
Width	19.0	±0.15	mm
Height	1.50	±0.30	mm
Light Emitting Surface (LES) Diameter	14.5	±0.30	mm

Note: Denoted product information above is only an example  
 ( LC019D28030 : LC019D, Gen2, CRI80+, 3000K )

## 5. Reliability Test Items & Conditions

### a) Test Items

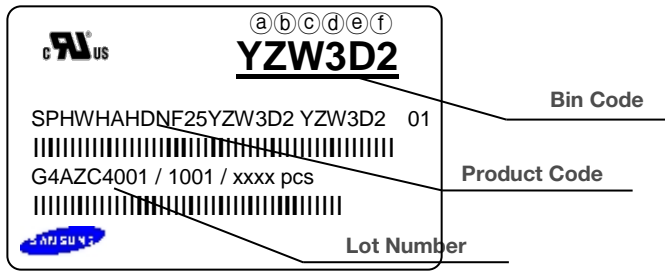
Test Item	Test Condition	Test Hour / Cycle
High Temperature Humidity Life Test	60 °C, 90 % RH,, DC Derating, $I_F$	1000 h
High Temperature Life Test	85 °C, DC Derating, $I_F$	1000 h
Low Temperature Life Test	-40 °C, DC, Derating $I_F$	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
Temperature Humidity Storage	60 °C, 90% RH	1000h
Temperature Cycle On/Off Test	-40 °C / 85 °C each 20 min, 30 min transfer power on/off each 5 min, DC Derating, $I_F = \text{max}$	100 cycles
ESD (HBM)	R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 1.5 kΩ C: 100 pF	5 times
ESD (MM)	R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 0 kΩ C: 200 pF	5 times
Vibration Test	20 ~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔ max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times

### b) Criteria for Judging the Damage

Item	Symbol	Test Condition ( $T_c = 25\text{ °C}$ )	Limit	
			Min.	Max.
Forward Voltage	$V_F$	$I_F = 540\text{ mA}$	L.S.L. * 0.9	U.S.L. * 1.1
Luminous Flux	$\Phi_v$	$I_F = 540\text{ mA}$	L.S.L * 0.7	U.S.L * 1.3

## 6. Label Structure

### a) Label Structure



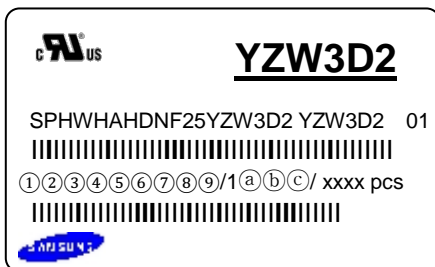
Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- ⒶⒷ: Forward Voltage bin (refer to page 11)
- ⒸⒹ: Chromaticity bin (refer to page 9-10)
- ⒺⒻ: Luminous Flux bin (refer to page 6)

### b) Lot Number

The lot number is composed of the following characters:



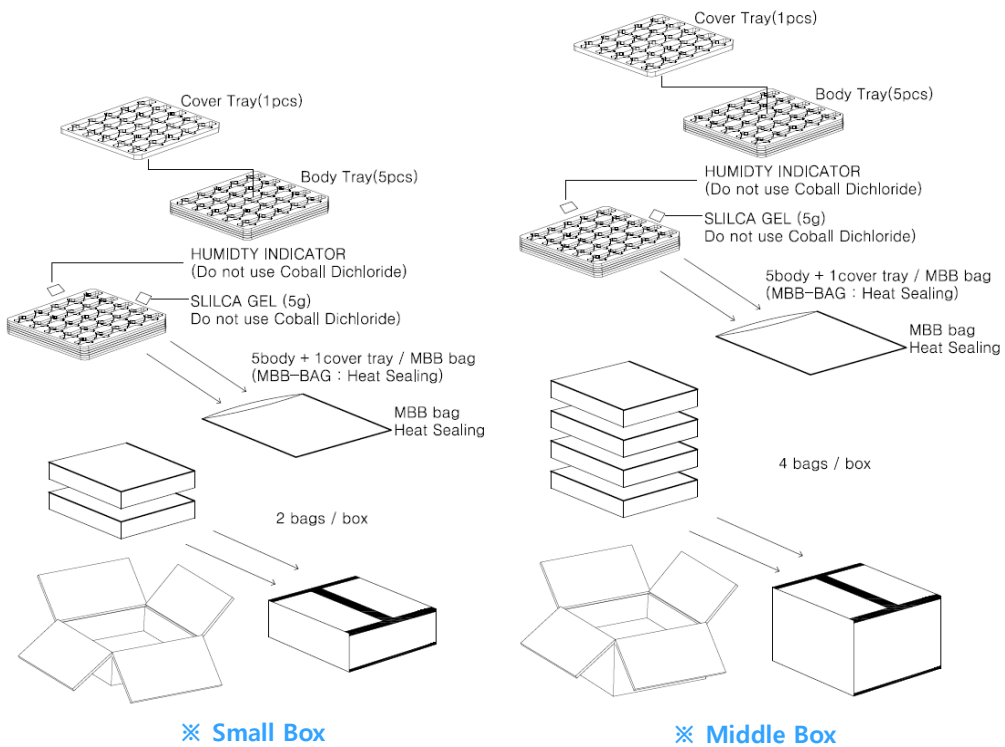
① ③④⑤⑥⑦⑧⑨ / 1ⒶⒷⒸ / xxxx pcs

- ① : Production site (S: Giheung, Korea, G: Tianjin, China)
- ② : 4 (LED)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (Z: 2015, A: 2016, B: 2017...)
- ⑤ : Month (1~9, A, B, C)
- ⑥⑦⑧⑨ : Day (1~9, A, B~V)
- ⒶⒷⒸ : Product serial number (001 ~ 999)

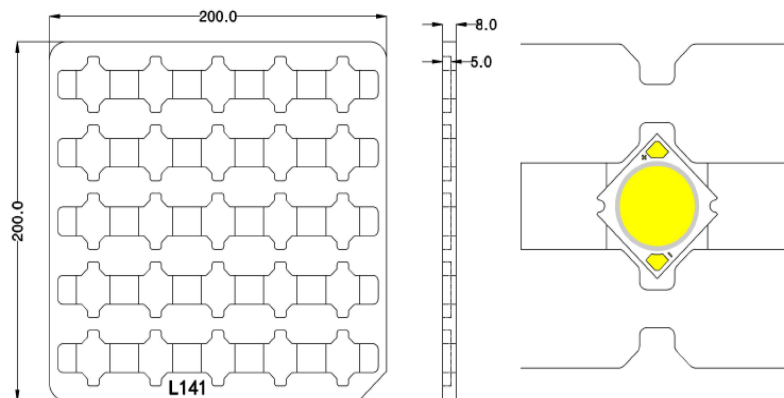
## 7. Packing Structure

Packing material	Max. quantity in pcs of COB	Dimension(mm)				Tolerance
		Length	Width	Height		
<b>Tray</b>	25	200	200	8	1	
<b>Aluminum Bag</b>	125 (5 trays)	320	270	-	+/- 0.5	
<b>Outer Box (Small)</b>	250 (2 bags)	225	225	65	5	
<b>Outer Box (Middle)</b>	500 (4 bags)	225	225	130	5	

### a) Packing Structure

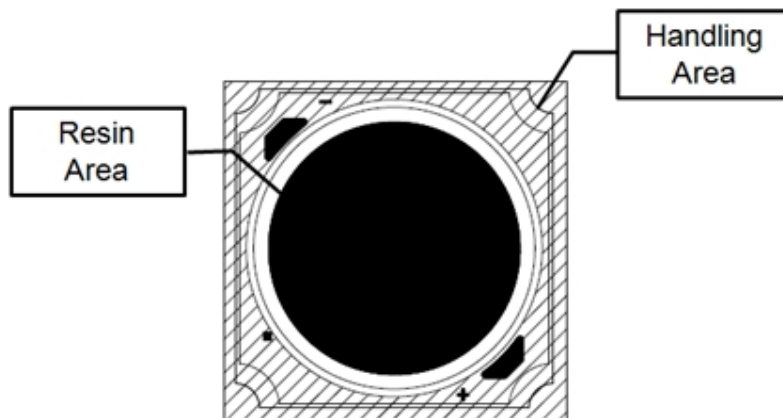


### b) Tray



## 8. Precautions in Handling & Use

- 1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
  - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
  - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.  
For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the minimum current level ( $I_{f\_min}$ ), chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



# Legal and additional information.

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